

# 15A, 60V Trench Schottky Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Patented Trench Schottky technology
- Low power loss, high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter
- Automotive

### **MECHANICAL DATA**

- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- · Polarity: Indicated by cathode band
- Weight: 0.104g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	15	Α	
$V_{RRM}$	60	V	
I <sub>FSM</sub>	290	Α	
$T_{JMAX}$	175	°C	
Package	TO-277A (SMPC4.6U)		
Configuration	Single die		

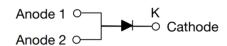








TO-277A (SMPC4.6U)



PARAMETER		SYMBOL	TSUP15M60SH	UNIT
Marking code on the device			15M60	
Repetitive peak reverse voltage		$V_{RRM}$	60	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	42	V
Forward current		I <sub>F</sub>	15	А
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms		290	
	t = 1.0ms	FSM	440	A
Junction temperature		TJ	-55 to +175	°C
Storage temperature		T <sub>STG</sub>	-55 to +175	°C

Version: B2103 1



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	4	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	48	°C/W
Junction-to-case thermal resistance	R <sub>eJC</sub>	7	°C/W

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	IF = 7.5A, T <sub>J</sub> = 25°C	V <sub>F</sub>	0.52	-	V
	$I_F = 15A, T_J = 25^{\circ}C$		0.58	0.64	V
	I <sub>F</sub> = 7.5A, T <sub>J</sub> = 125°C		0.43	-	V
	$I_F = 15A, T_J = 125^{\circ}C$		0.53	0.60	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C		-	450	μA
	T <sub>J</sub> = 125°C	- I <sub>R</sub>	-	20	mA
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	1046	-	pF

## Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TSUP15M60SH	TO-277A (SMPC4.6U)	6,000 / Tape & Reel	

2 Version: B2103



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

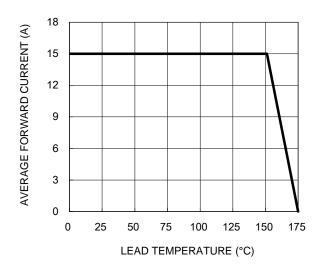


Fig.3 Typical Reverse Characteristics

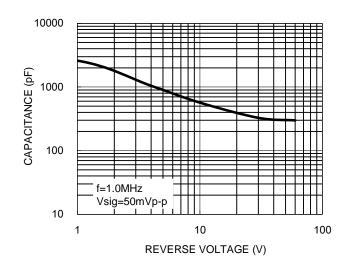
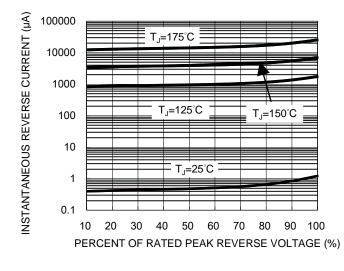


Fig.2 Typical Junction Capacitance

**Fig.4 Typical Forward Characteristics** 



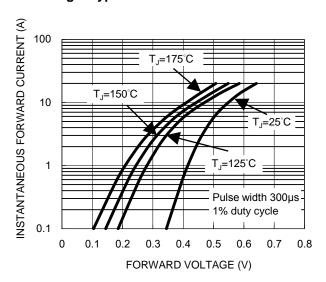
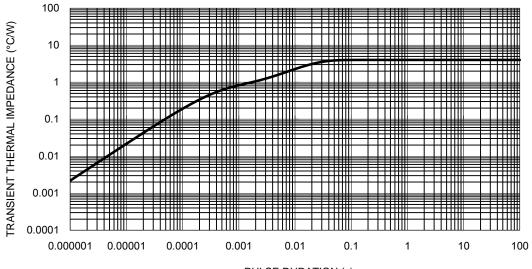


Fig.5 Typical Transient Thermal Impedance

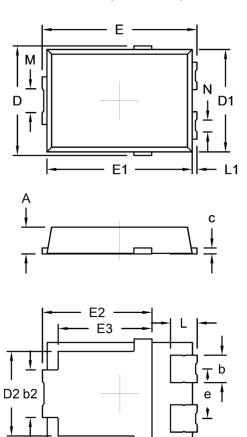


PULSE DURATION (s)



# **PACKAGE OUTLINE DIMENSIONS**

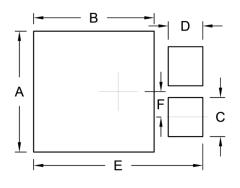
TO-277A (SMPC4.6U)



DIM.	Unit (mm)		Unit (	inch)
DIWI.	Min.	Max.	Min.	Max.
Α	1.00	1.20	0.039	0.047
b	1.05	1.35	0.041	0.053
b2	1.90	2.20	0.075	0.087
b4	0.75 (NOM.)		0.030 (NOM.)	
С	0.15	0.40	0.006	0.016
D	4.45	4.75	0.175	0.187
D1	4.25	4.35	0.167	0.171
D2	3.40	3.70	0.134	0.146
E	6.35	6.65	0.250	0.262
E1	6.05	6.15	0.238	0.242
E2	4.40	4.80	0.173	0.189
E3	3.94 (NOM.)		0.155	(NOM.)
е	2.08 (NOM.)		0.082 (NOM.)	
L	0.94	1.24	0.037	0.049
L1	0.05	0.35	0.002	0.014
М	0.65	1.15	0.026	0.045
N	0.25	0.75	0.010	0.030

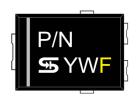
Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

# **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	4.95	0.195
В	4.95	0.195
С	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

# **MARKING DIAGRAM**



P/N = Marking Code ΥW = Date Code F = Factory Code



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5 Version: B2103